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Fairchild Semiconductor FCPF16N60NT

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FAIRCHILD

SEMICONDUCTOR

FCP16N60N / FCPF16N60NT N-Channel SupreMOS[®] MOSFET 600 V, 16 A, 199 mΩ

Features

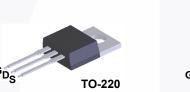
- R_{DS(on)} = 170 mΩ (Typ.) @ V_{GS} = 10 V, I_D = 8 A
- Ultra Low Gate Charge (Typ. Q_g = 40.2 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 176 pF)
- 100% Avalanche Tested
- RoHS Compliant

Application

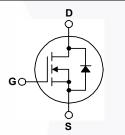
- LCD/LED/PDP TV
- Lighting
- Solar Inverter
- AC-DC Power Supply

Description

The SupreMOS[®] MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.







Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol		Parameter	FCP16N60N	FCPF16N60NT	Unit		
V _{DSS}	Drain to Source Voltage		6	V			
V _{GSS}	Gate to Source Voltage	±	V				
ID	Droin Current	- Continuous (T _C = 25 ^o C)	- Continuous (T _C = 25 ^o C)		16.0*	•	
	Drain Current	- Continuous (T _C = 100 ^o C)		10.1	10.1*	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	48.0	48.0*	А	
E _{AS}	Single Pulsed Avalanche	3	mJ				
I _{AR}	Avalanche Current		(Note 1)	5.3		А	
E _{AR}	Repetitive Avalanche Ene	rgy	(Note 1)	1.34		mJ	
	MOSFET dv/dt				100		
dv/dt	Peak Diode Recovery dv/	(Note 3)	20		V/ns		
P _D	De la Discissión	(T _C = 25 ^o C)	$(T_{\rm C} = 25^{\rm o}{\rm C})$		35.7	W	
	Power Dissipation	- Derate Above 25°C	- Derate Above 25°C		0.29	W/ºC	
T _J , T _{STG}	Operating and Storage Te	-55 to	°C				
TL	Maximum Lead Temperate	ure for Soldering, 1/8" from Case for §	3	°C			
1	Maximum Lead Temperati	3	00				

*Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	FCP16N60N	FCPF16N60NT	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.93	3.5	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	62.5	62.5	00/00

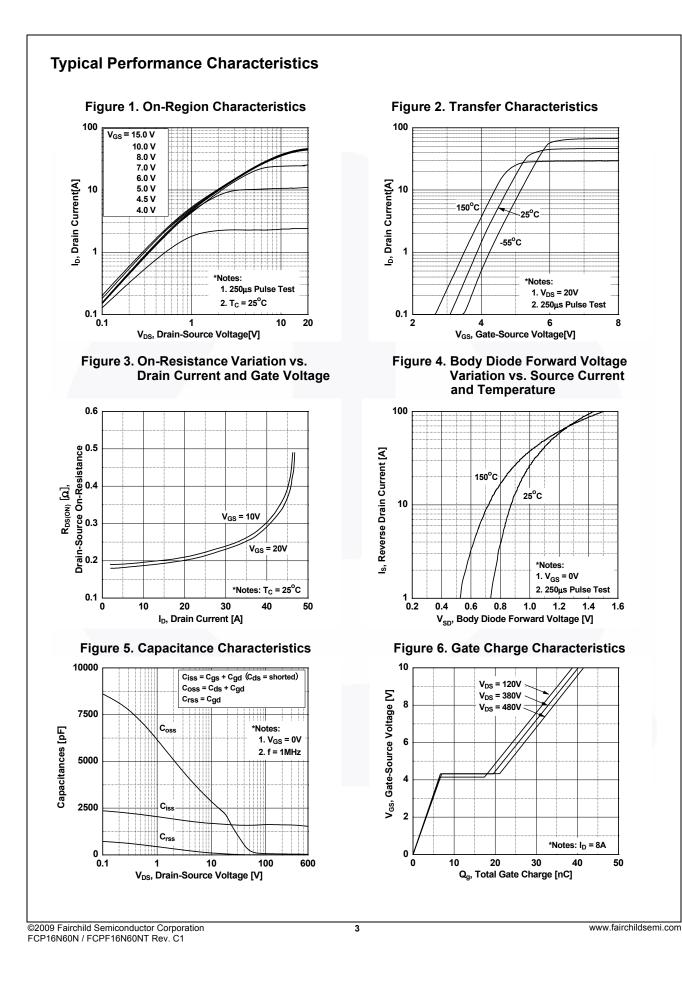
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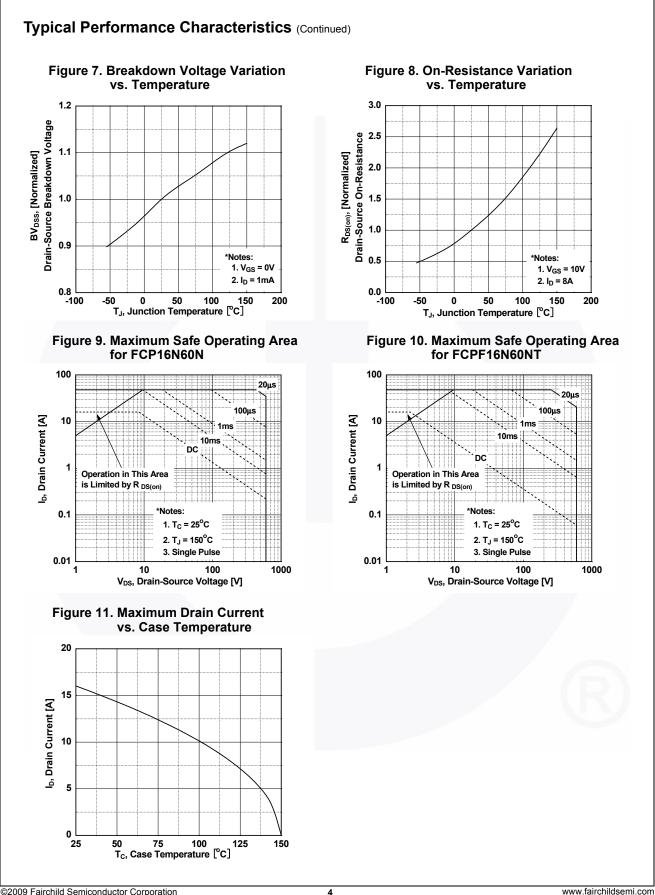


FCP16N60N FCP16N60N TC		Packa	ackagePacking MethodReel SizerO-220TubeN/AO-220FTubeN/A		Ta	Tape Width		antity		
		TO-2			N/A N/A		50 units 50 units			
		TO-22								
Electrica	l Char	acteristics T _C = 2	5ºC unles	s oth	erwise noted.					
Symbol		Parameter	_		Test Conditio	ns	Min.	Тур.	Max.	Unit
Off Charac	teristic	s								
BV _{DSS}	Drain to	Source Breakdown Voli	age	ID	= 1 mA, V _{GS} = 0V, T _C	₂ = 25 ^o C	600	-	-	V
ΔBV _{DSS}			9	$I_D = 1 \text{ mA}$, Referenced to 25° C				0.72		V/°C
$/\Delta T_{J}$	Coeffici	ent				0 25 °C	-	0.73	-	V/°C
 	Zero Gate Voltage Drain Current				$_{\rm DS}$ = 480 V, V _{GS} = 0 V		-	-	10	μA
DSS	Zero Gale voltage Drain Gurrent		•	V_{DS} = 480 V, V_{GS} = 0 V, T_{C} = 125°C			-	-	100	μ
I _{GSS}	Gate to Body Leakage Current		_	V_{GS} = ±30 V, V_{DS} = 0 V			-	-	±100	nA
On Charac	teristic	s								
V _{GS(th)}	Gate TI	hreshold Voltage		V	_{GS} = V _{DS} , I _D = 250 μA		2.0	-	4.0	V
R _{DS(on)}	Static D	rain to Source On Resis	tance	V	_{GS} = 10 V, I _D = 8 A		-	0.170	0.199	Ω
9 _{FS}	Forward	d Transconductance		V	_{DS} = 40 V, I _D = 8 A		-	13	I	S
Dynamic C	haracte	eristics								
C _{iss}	Input Capacitance						<u>.</u>	1630	2170	pF
C _{oss}		Capacitance			$V_{\rm DS} = 100 \text{ V}, V_{\rm GS} = 0 \text{ V},$		_	70	95	pF
C _{rss}	-	Reverse Transfer Capacitance		f = 1 MHz				5	10	pF
C _{oss}	Output Capacitance		-	V	_{DS} = 380 V, V _{GS} = 0 V	f = 1 MHz		40	60	pF
C _{oss(eff.)}	Effective Output Capacitance			$V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$				176	-	pF
Q _{q(tot)}		Total Gate Charge at 10V					-	40.2	52.3	nC
Q _{gs}		Source Gate Charge			_ V _{DS} = 380 V, I _D = 8 A, V _{GS} = 10 V		-	6.7	-	nC
Q _{gd}	Gate to Drain "Miller" Charge			(Note 4)			-	12.9	-	nC
ESR	Equivalent Series Resistance (G-S)		6-S)	f = 1 MHz				2.9		Ω
Switching	Charac	teristics				ŀ				
t _{d(on)}	-							15.8	41.6	ns
t _r	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time			V	, = 380 V, I _D = 8 A	-		15.5	41.0	ns
				$V_{GS} = 10 \text{ V}, \text{ R}_{G} = 4.7 \Omega$			-	60.3	130.6	ns
t _f		f Fall Time		(Note 4)			_	20.2	50.4	ns
						(1010 4)				
		de Characteristics		do Fr	anuard Current				10	•
l _s	Maximum Continuous Drain to Source D						-	-	16	A
I _{SM}	Maximum Pulsed Drain to Source Diode						-	-	48	A V
V _{SD}		ain to Source Diode Forward Voltage		$V_{GS} = 0 V, I_{SD} = 8 A$		-	-	1.2	-	
$\frac{t_{rr}}{0}$		Reverse Recovery Time Reverse Recovery Charge		V _{GS} = 0 V, I _{SD} = 8 A, dI _F /dt = 100 A/μs			-	319 4.4		ns µC
Q _{rr}	Reveise	e Recovery Charge		u.	F/dt 1007740		-	4.4		μΟ
2. I_{AS} = 5.3 A, R _G 3. $I_{SD} \le 16$ A, di/dt	= 25 Ω, startin ≤ 200 A/μs, \	limited by maximum junction ten ng T _J = 25°C. V_{DD} = 380 V, starting T _J = 25°C berating temperature typical char.								



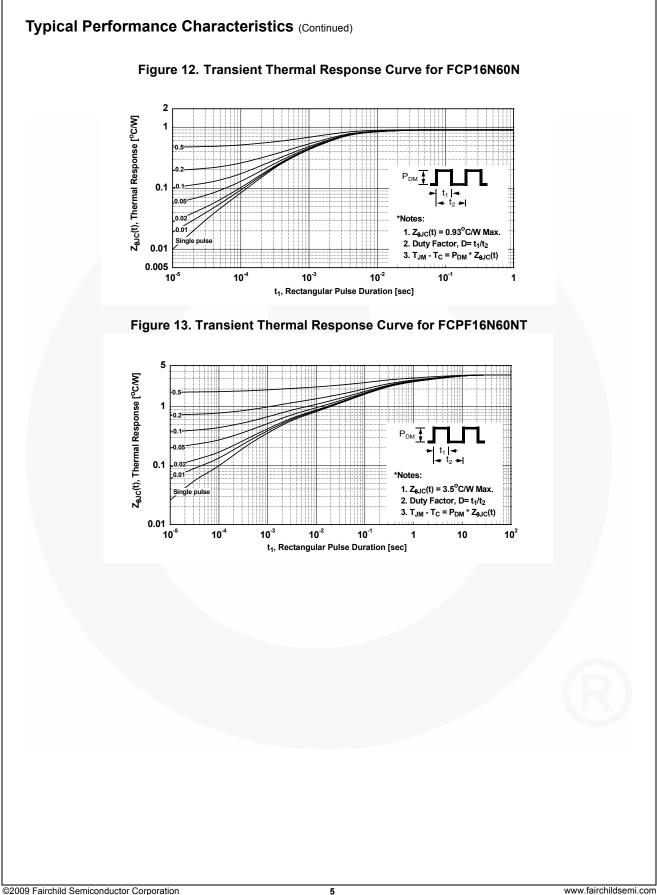




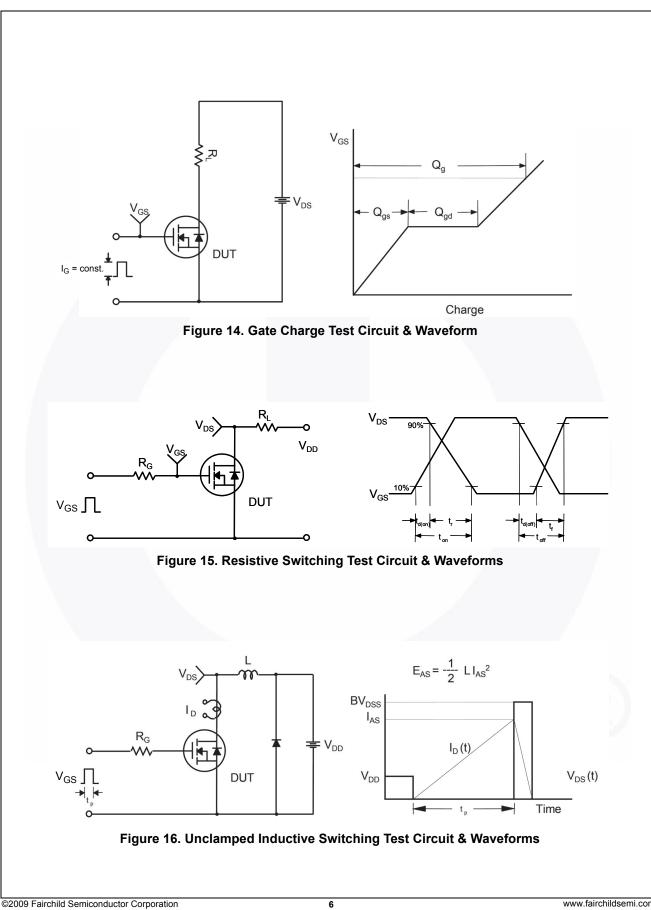


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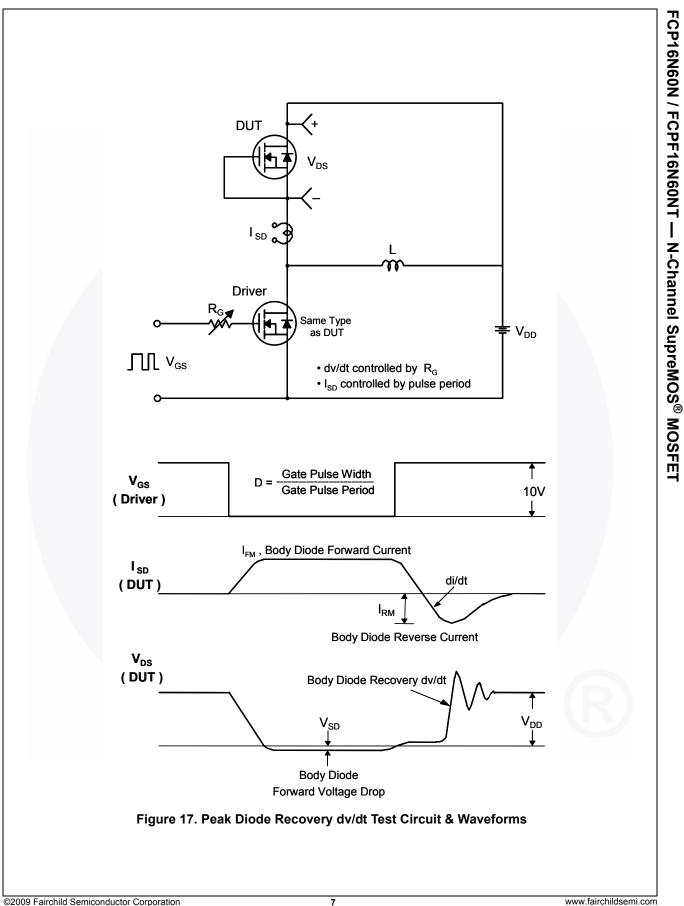




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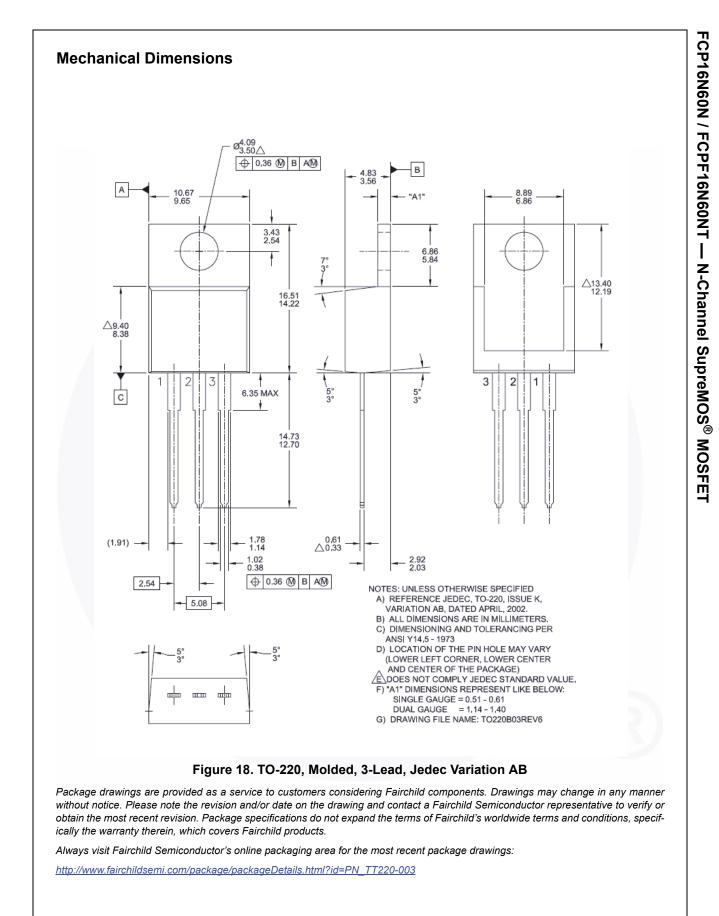




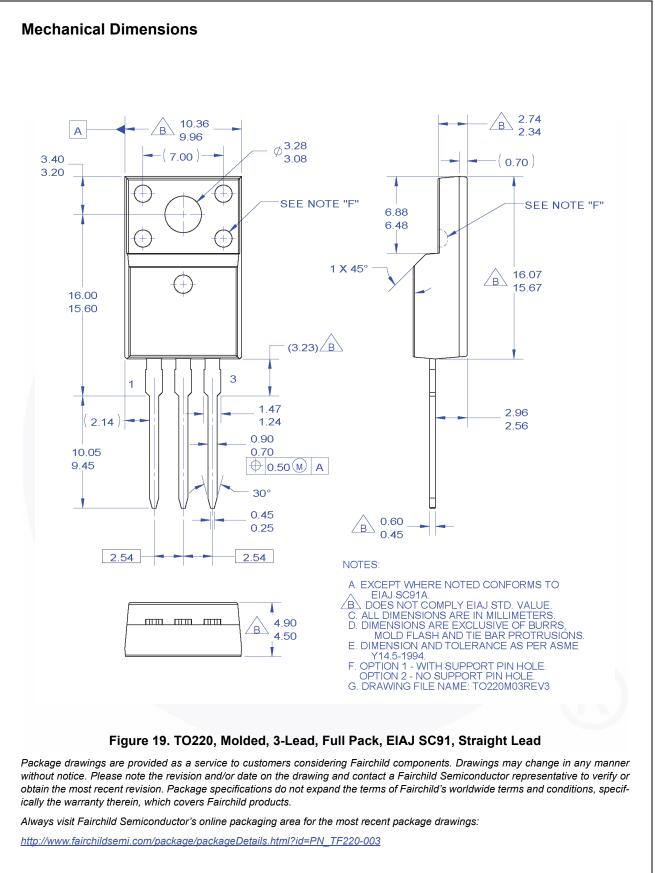
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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.			
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.			
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.			